Notification Number: 20151202000			00	Notification Date: 02/24/2016					
Title:	Datasheet up	odate for HDC10	ite for HDC1008						
Customer Contact:		PCN Manager	PCN Manager			pt:	Quality Services		
Change Type:									
Assembly Site Design						Wafer	Bum	p Site	
			Data Sheet		Wafer Bump Material			p Material	
Assembly Materials Part n			Part number chan	ge	Wafer Bump Process				
			Test Site		Wafer Fab Site				
	king/Shipping/	/Labeling	Test Process					Materials	
						Wafer	Fab	Process	
Notification Details									
Description of Change:									
Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is updated as seen in the change revision history below:									
TEXAS INSTRUMENTS									
HDC1008									
SNAS649B – OCTOBER 2014 – REVISED DECEMBER 2015 www.ti.e								www.ti.com	
Changes from Revision A (November 2014) to Revision B Page									
Deleted references to functional and operating temperature ranges.									
Changed wording to clarify									
Moved Storage Temperature to Abs Max Rating Table									
Changed Handling Ratings table to ESD Ratings table									
Added separate conditions for RH									
Added RH condition									
Added figure reference.									
Added condition									
Changed wording to clarify hysteresis definition									
Changed recommended operating range5									
Changed register reference for supply voltage monitoring. The original reference was incorrect									
Added recommendation for recovery from soldering									
The datasheet number will be changing.									
	Family		Change From:		Ch	ange T	o:		
HDC10	DC1008 SNAS649A		SNAS649A		SNAS649B				
These changes may be reviewed at the datasheet links provided.									
http://www.ti.com/product/hdc1008									
Reason for Change:									
To more accurately reflect device characteristics.									
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):									
No anticipated impact. This is a specification change announcement only. There are no changes									
to the actual device.									
Changes to product identification resulting from this Notification:									
None.									
Produc	t Affected:								
HDC10	08YPAR		HDC100	8YPAT					
For questions regarding this notice, e-mails can be sent to the regional contacts shown below									
or your local Field Sales Representative.									
Locatio	n		E-Mail						
				AmericasContact@list.ti.com					
Europe			PCNEuropeContact@list.ti.com						
	Asia Pacific <u>PCNAsiaContact@list.ti.com</u>								
Japan			<b>PCNJapanC</b>	ontact@li	st.ti	.com			